



HOSONIC ELECTRONIC CO., LTD.



CRYSTAL UNIT SPECIFICATIONS

Customer	ADS
Customer P/N	
Product	49SA CRYSTAL
Nominal Frequency	32.000000MHz
HOSONIC P/N	E49A32E000007E
Version	10C0
Issue Date	2016/6/28

HOSONIC		
Drawn	Checked	Approved
LUCY	ZOE	JOHN

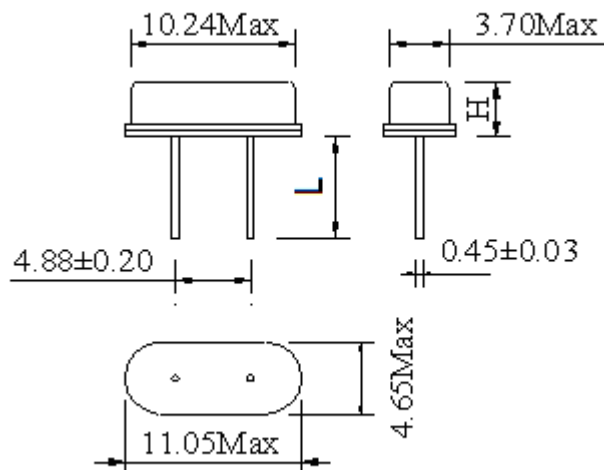
Approved By Customer : _____

Revised Record				
Rev.	Rev. Date	Item	Content	Remark
1.0	2016-06-28		Initial released	

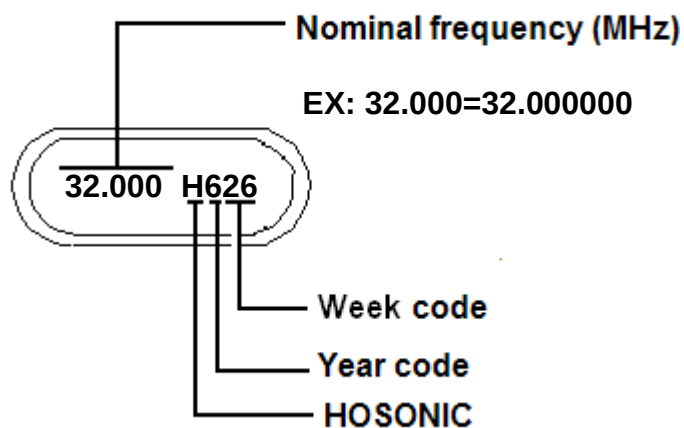
I ELECTRICAL PARAMETERS

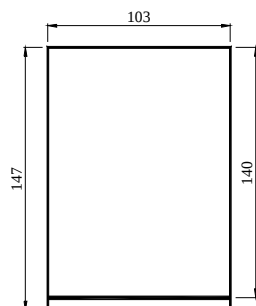
No.	Item	Symb.	Electrical Specification				Remark
			Min.	Typ.	Max.	Units	
1	Nominal Frequency	F0	32.000000			MHz	
2	Mode of Vibration		Fundamental				
3	Frequency Tolerance	$\Delta F/F0$	-10	-	10	ppm	at 25°C±3°C
4	Operating Temperature Range	T _{OPR}	-20	-	70	°C	
5	Frequency Stability (over operating temperature)	TC	-10	-	10	ppm	Ref. to 25°C
6	Storage Temperature	T _{STG}	-55	-	125	°C	
7	Load capacitance	CL	-	18	-	pF	
8	Equivalent Series Resistance	ESR	-	-	40	Ω	
9	Drive Level	DL	-	100	500	μW	
10	Insulation Resistance	IR	500	-	-	MΩ	At 100V _{DC}
11	Shunt Capacitance	C0	-	-	7	pF	
12	Aging Per Year	Fa	-5	-	5	ppm	First Year
13	Package type	HC-49SA					

NOTE: Storage Temperature is only for the product itself,the temperature for the packing material is -4~40°C .

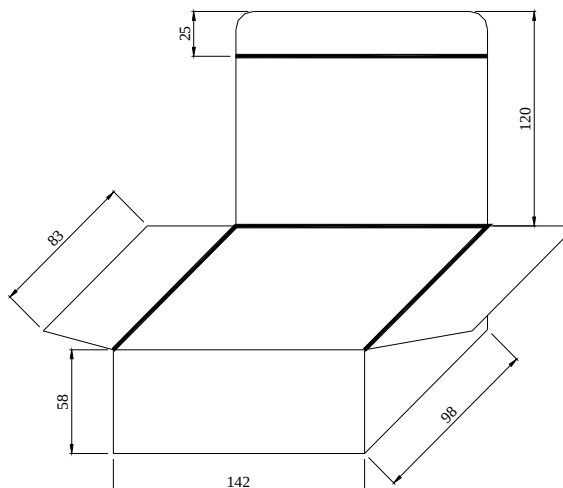
I Outline Dimensions (unit: mm)


$$L = 6.0 \pm 0.5 \quad H = 3.5 \text{MAX}$$

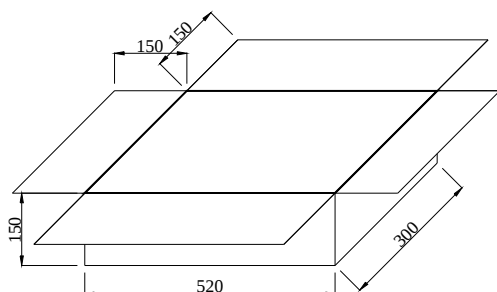
I MARKING


I PACKAGE (units : mm)


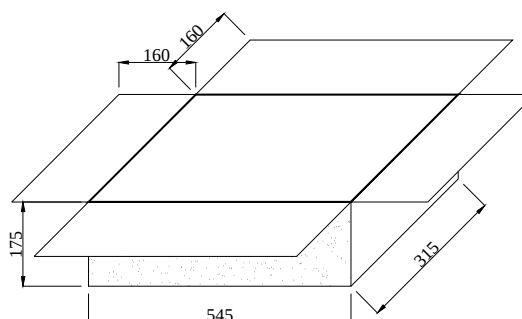
200 PCS = 1 BAG



5 BAGS = 1 INNER BOX



20 INNER BOX = 1 BOX



1 BOX = 1 OUTER BOX

* 20 K PCS = 1 OUTER BOX

I RELIABILITY SPECIFICATIONS

No.	Test Item	Test Conditions	Reference
1	High Temperature Storage	Temperature: $125^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Time: 1000 ± 12 Hours	MIL-STD-883E-1016
2	Temperature Cycle	Temperature 1: $-55^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Temperature 2: $125^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Temperature change between T1 and T2 at soonest Run 1000 cycles, maintain T1 and T2 5minutes each in one cycle	JESD22 Method JA-104
3	Solder Heat Resistance	Pre-heat: 125°C 60~120 Seconds Solder Temperature: $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Time: 30 Seconds	MIL-STD-202F 210 E
4	Drop Test	3 Times Free Fall from 75cm height table to 3cm thickness hard wood board	MIL-STD-202F-203B
5	High Temperature, High Humidity Storage	Temperature: $85^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Relative Humidity: 80%~85% Time: 250Hours $\pm$ 24 Hours	MIL-STD-202F-103B
6	Steam Aging	Temperature: $97^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Time: 24 Hours 260°C solder pot to check solderability	MIL-STD-883 C-1008.2B
7	Solderability	Dip in flux 5~10 seconds Temperature: $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Time: 10 Seconds	MIL-STD-202F-208H
8	Aging	Temperature: $85^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Time: 250 ± 12 Hours	MIL-STD-202 F-108A
9	Thermal Shock	Temperature 1: $-55^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Temperature 2: $125^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Temperature change between T1 and T2: 5 seconds 100 cycles, maintain T1 and T2 for 30 minutes each in one cycle	MIL-STD-883E-1011.9B
10	Vibration	Frequency Range: 10Hz~2000Hz Amplitude: 1.5mm or 20G 4Hours in each direction, total 12Hours	MIL-STD-202F-204D